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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Seong-Nam LEE	08/04/2008
Jeong-Uk HEO	08/04/2008
Nam-Seok LEE	08/04/2008
Jun-Hyup LEE	08/04/2008
Jung-Hun LEE	08/04/2008

RECEIVING PARTY DATA

Name:	Samsung Electronics Co., Ltd.
Street Address:	416, Maetan 3-dong, Yeongtong-gu
City:	Suwon-si, Gyeonggi-do
State/Country:	REPUBLIC OF KOREA

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12241676

CORRESPONDENCE DATA

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Correspondent Name: Cantor Colburn LLP
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ATTORNEY DOCKET NUMBER:	HAA-0121
NAME OF SUBMITTER:	Dana A. Gronbeck

Total Attachments: 2

PATENT REEL: 021609 FRAME: 0230

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PATENT REEL: 021609 FRAME: 0231

ASSIGNMENT

WHEREAS We Seong-Nam LEE of 102-1401, Bukhangang Sungwon Apt., Icho n-dong, Yongsan-gu, Seoul, Republic of Korea and Jeong-Uk HEO of #409-1801, Kkac hi Maeul Sunkyoung Apt., Gumi-dong, Bundang-gu, Seongnam-si, Gyeonggi-do, Republic of Korea and Nam-Seok LEE of 107-1203, Jugong GreenVill Apt., #1258 Maetan-don g, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea and Jun-Hyup LEE of 105-1003, Doosan Apt., Bukahyeon 2-dong, Seodaemun-gu, Seoul, Republic of Korea and Jung-Hun LEE of #1594-3 Sillim 1-dong, Gwanak-gu, Seoul, Republic of (hereinafter referred to as "ASSIGNORS") have invented certain new and useful improvements in:

END-SEALANT COMPOSITION, LIQUID CRYSTAL DISPLAY PANEL, AND MET HOD OF MANUFACTURING LIQUID CRYSTAL DISPLAY PANEL

which claims priority to Korean Patent Application No.10-2007-104019, filed October 16, 2007, and for which We are about to file or have filed an application for Letters Patent of the United States;

AND WHEREAS, SAMSUNG ELECTRONICS CO., LTD (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Korea, having a place of business at 416, Maetan 3-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof,

PATENT REEL: 021609 FRAME: 0232 to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: Aug., 04, 2008	Seong-Nam LEE	L.S
Date: Dug of 2005	Jeong-Uk HEO	L.S
Date: Aug 04 2008	Nam-Seok LEE	L.S
Date: Ang. 04. hos 8	Jun-Hyup LEE	L.S
Date: Aug. 04, 2008	Jung-Hun KEF	L.S

PATENT REEL: 021609 FRAME: 0233

RECORDED: 09/30/2008